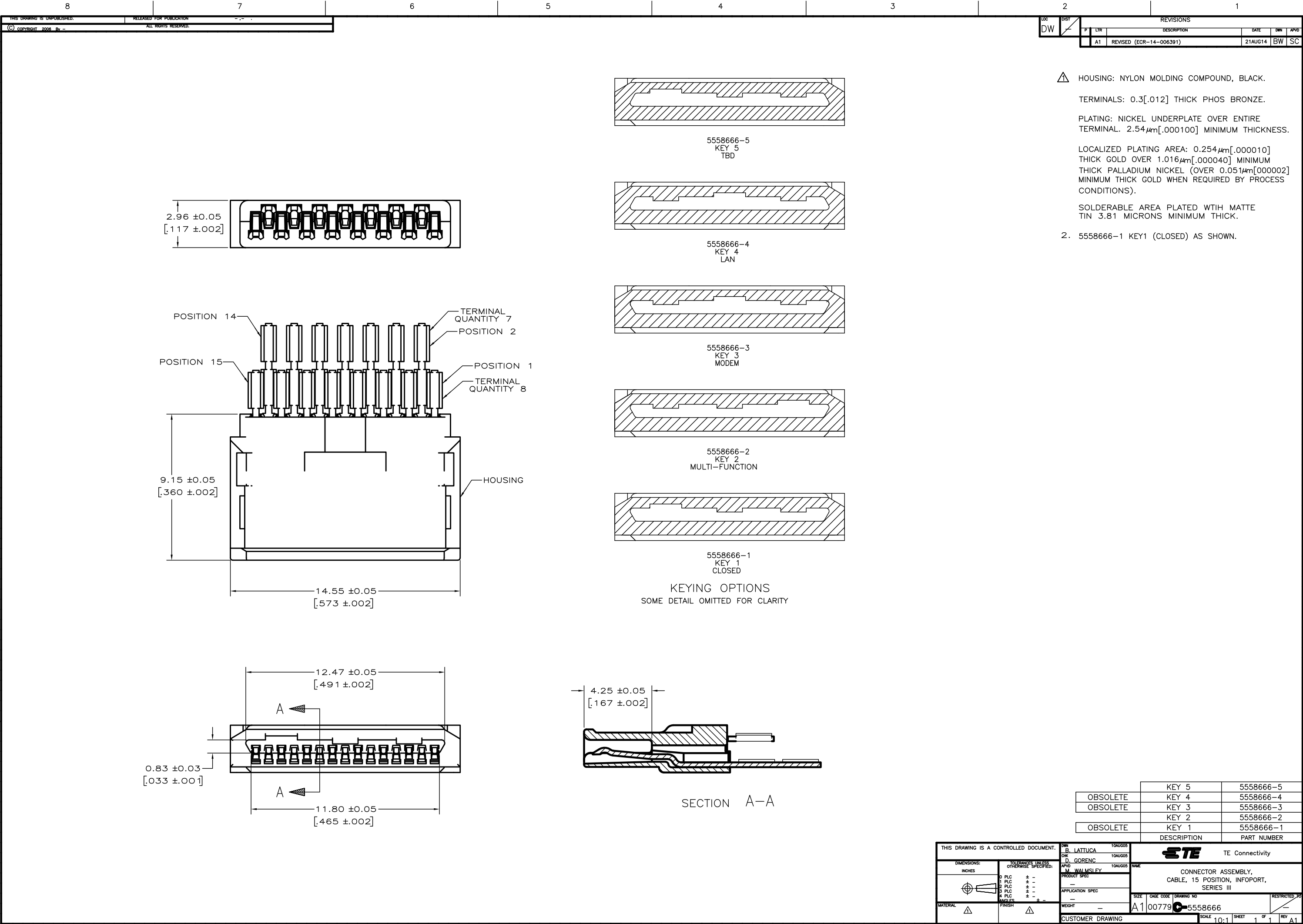




△ HOUSING: NYLON MOLDING COMPOUND, BLACK.

TERMINALS: 0.3[.012] THICK PHOS BRONZE.

PLATING: NICKEL UNDERPLATE OVER ENTIRE TERMINAL. 2.54 μ m[.000100] MINIMUM THICKNESS.

LOCALIZED PLATING AREA: 0.254 μ m[.000010] THICK GOLD OVER 1.016 μ m[.000040] MINIMUM THICK PALLADIUM NICKEL (OVER 0.051 μ m[000002] MINIMUM THICK GOLD WHEN REQUIRED BY PROCESS CONDITIONS).

SOLDERABLE AREA PLATED WITH MATTE TIN 3.81 MICRONS MINIMUM THICK.

2. 5558666-1 KEY1 (CLOSED) AS SHOWN.

	KEY 5	5558666-5
OBSOLETE	KEY 4	5558666-4
OBSOLETE	KEY 3	5558666-3
	KEY 2	5558666-2
OBSOLETE	KEY 1	5558666-1
	DESCRIPTION	PART NUMBER

THIS DRAWING IS A CONTROLLED DOCUMENT.		DWG B. LATTUCA 10AUG05		TE Connectivity	
CHK D. GORENC 10AUG05		NAME		CONNECTOR ASSEMBLY, CABLE, 15 POSITION, INFOPORT, SERIES III	
APPRO M. WALMSLEY 10AUG05		PRODUCT SPEC		RESTRICTED TO	
APPLICATION SPEC		WEIGHT		A1 00779 C 5558666	
MATERIAL		FINISH		SCALE 10:1 SHEET 1 OF 1 REV A1	
CUSTOMER DRAWING					

Mouser Electronics

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[TE Connectivity:](#)

[5558666-2](#)